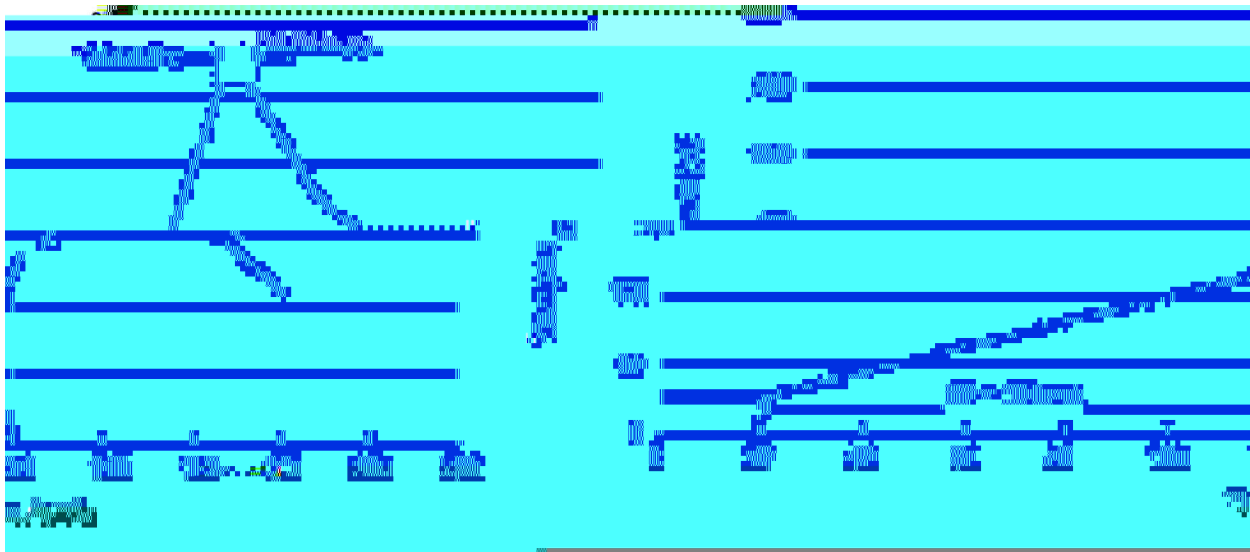


2SA743(A)
Rev.E Mar.-2016

Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	-50	V

() / Temperature Profile for Dip Soldering(Pb-Free)



б " X

1. 1. 25~150 °C, Time: 60~90sec;
2. 2. 255 °C, Duration: 5 ° 0.5sec;
3. 3. Cooling Speed: 2~10 ° /sec.

Note:

1. Preheating: 25~150 °C, Time: 60~90sec.
2. Peak Temp.: 255 °C, Duration: 5 ° 0.5sec.
3. Cooling Speed: 2~10 ° /sec.

/ Resistance to Soldering Heat Test Conditions

□ °C 270 ± 5 °C, Time: 10 ± 1 sec. Temp.: 270 ± 5 °C Time: 10 ± 1 sec

/ Packaging SPEC.

“Q T Y E / BULK

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)
	只 套管	套管 盒	只 盒	盒 箱	只 箱	套管)